



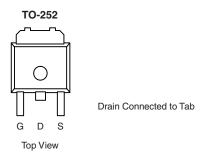
P-Channel 30-V (D-S), MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a			
- 30	0.010 at V _{GS} = - 10 V	- 15			
	0.018 at V _{GS} = - 4.5 V	- 12			

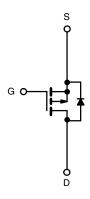
FEATURES

• TrenchFET® Power MOSFETs





Ordering Information: SUD45P03-10-E3 (Lead (Pb)-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 30	V		
Gate-Source Voltage	V _{GS}	± 20	_ v			
Ocation and David Ocation	T _A = 25 °C	1-	- 15			
Continuous Drain Current ^b	T _A = 100 °C	l _D	- 8			
Pulsed Drain Current	I _{DM}	- 100	Α			
Continuous Source Current (Diode Conduction)	I _S	- 15				
Mariana Branco Birata di Jah	T _C = 25 °C	P _D	70	W		
Maximum Power Dissipation ^b	T _A = 25 °C		4 ^b			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^b	R _{thJA}		30 °C/W				
Maximum Junction-to-Case	R _{thJC}		1.8				

Notes

- a. Calculated Rating for $T_A = 25$ °C, for comparison purposes only. This cannot be used as continuous rating (see Absolute Maximum Ratings and Typical Characteristics).
- b. Surface Mounted on FR4 board, $t \le 10 \text{ s.}$

SUD45P03-10

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
7 0 1 1/1 5 1 0 1		V _{DS} = - 30 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μΑ	
On Otata Dunin Communità	1	V _{DS} = - 5 V, V _{GS} = - 10 V	- 50			А	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 4.5 V	- 20				
		V _{GS} = - 10 V, I _D = - 15 A			0.010	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 15 A, T _J = 125 °C			0.015		
		V _{GS} = - 4.5 V, I _D = - 15 A			0.018		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 15 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			6000		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$		1100			
Reverse Transfer Capacitance	C _{rss}			700			
Total Gate Charge ^c	Q_g			90	150		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -45 \text{ A}$		20		nC	
Gate-Drain Charge ^c	Q_{gd}			16			
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	V_{DD} = - 15 V, R_{L} = 0.33 Ω		375	550	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 45 A, V_{GEN} = - 10 V, R_G = 2.4 Ω		100	200		
Fall Time ^c	t _f]		140	250		
Source-Drain Diode Ratings and Cha	racteristic T	_C = 25 °C					
Pulsed Current	I _{SM}				100	Α	
Diode Forward Voltage ^a	V_{SD}	I _F = - 45 A, V _{GS} = 0 V		1.0	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 45 A, dI/dt = 100 A/μs		55	100	ns	

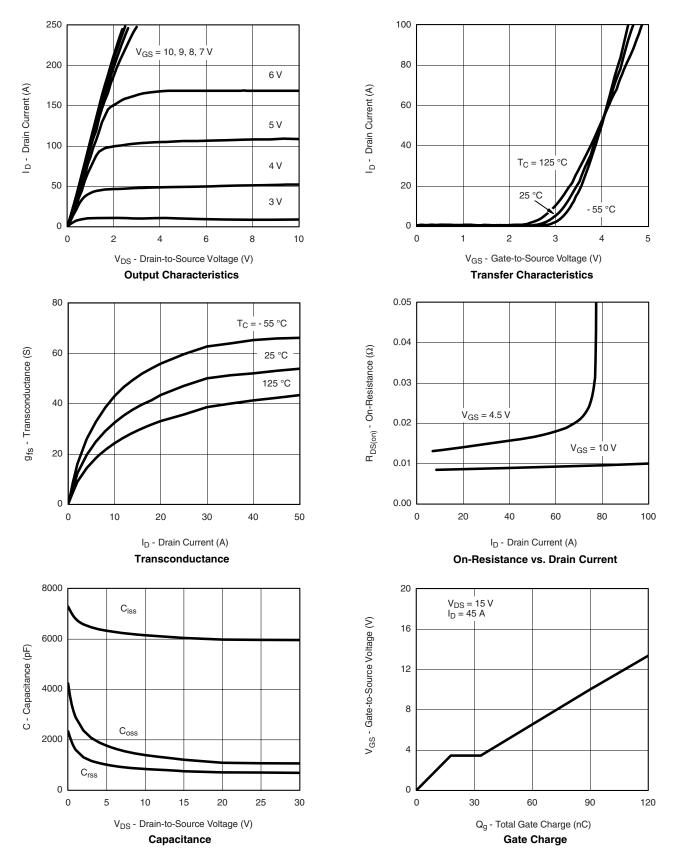
Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



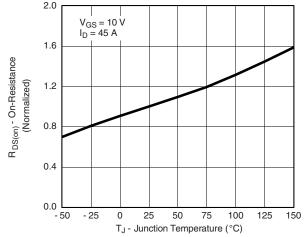
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



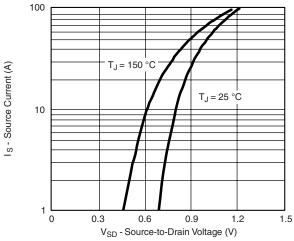
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

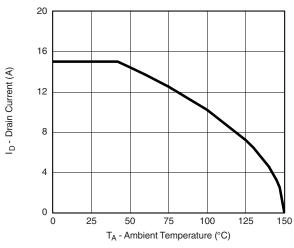


On-Resistance vs. Junction Temperature

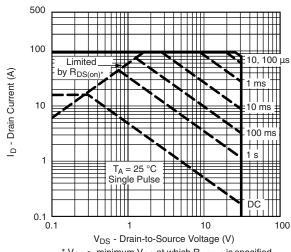


Source-Drain Diode Forward Voltage

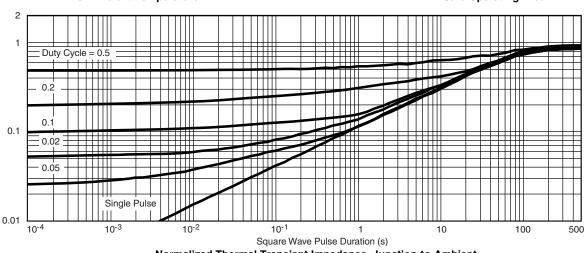
THERMAL RATINGS



Maximum Drain Current vs. Ambient Temperature



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified **Safe Operating Area**



Normalized Thermal Transient Impedance, Junction-to-Ambient

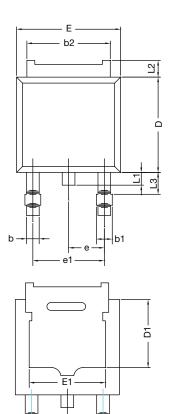
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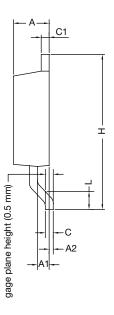
Normalized Effective Transient Thermal Impedance



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TO-252AA CASE OUTLINE





	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
A2	0.030	0.127	0.001	0.005	
b	0.71	0.88	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.44	0.206	0.214	
С	0.46	0.58	0.018	0.023	
C1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
D1	4.10	4.45	0.161	0.175	
Е	6.48	6.73	0.255	0.265	
E1	4.49	5.50	0.177	0.217	
е	2.28	BSC	0.090	BSC	
e1	4.57	BSC	0.180	BSC	
Η	9.65	10.41	0.380	0.410	
L	1.40	1.78	0.055	0.070	
L1	0.64	1.02	0.025	0.040	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.040	0.060	
ECN: T11-0110-Rev. L, 18-Apr-11 DWG: 5347					

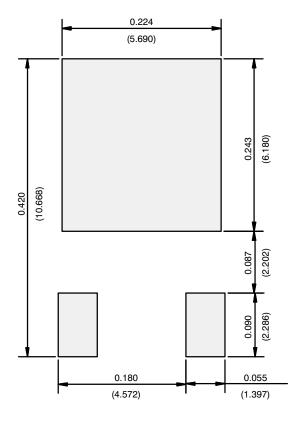
Note

• Dimension L3 is for reference only.

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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